U.S. PTO 11/704323

02/09/2007 U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

Form PTO-1595 (Rev. 08/05) OMB No. 0851-0027 (exp. 8/30/2008)



103377952	
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.	
	2. Name and address of receiving party(ies)
Kumata	Name: Sony Corporation
	Internal Address:
al name(s) of conveying party(les) attached? Yes X No	Street Address:
ure of conveyance/Execution Date(s):	4.7.4 Kanan Minata ku
ion Date(s): February 1, 2007	1-7-1 Konan, Minato-ku Tokyo, Japan
signment Merger Change of Name	
curity Agreement Joint Research Agreement	City:
	State:
ecutive Order 9424, Confirmatory License	Country: Zip:
	Additional name(s) & address(es) Yes X No attached?
ent Application No.(s)	is document is being filed together with a new application. B. Patent No.(s)
Additional numbers attached?	Yes X No
and address to whom correspondence rning document should be mailed:	i. Total number of applications and patents involved:
Ronald P. Kananen RADER, FISHMAN & GRAUER PLLC	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Address: Atty. Dkt.: SON-3700	Authorized to be charged by credit card
Address: 1233 20th Street, N.W. Suite 501	Authorized to be charged to deposit account
June 301	Enclosed
·	None required (government interest not affecting title)
Washington	. Payment Information
DC Zip: 20036	a. Credit Card Last 4 Numbers
Number: (202) 955-3750	Expiration Date

	AUTION OSE NAME NOTICE NOTICE NOTICE
ure:	February 9, 2007
Signatyre	Date
Ronald P. Kanener - 24,104	Total number of pages including cover sheet, attachments, and documents:
RMA1 00000084 18001% 11704323	
mber: (202) 955-3751 ddress: rpk@raderfishman.com ture: Signature	b. Deposit Account Number Authorized User Name Ronald P. Kananen February 9, 2007 Date Total number of pages including cover

03/0

01 FC:8021

40.00 DA

REEL: 018983 FRAME: 0825

S07P0161US00

Docket Number: SON-3700

<u>ASSIGNMENT</u>

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

DIGITAL DLL CIRCUIT

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto:

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of recapplication in the spaces that follow: Serial Number:	ord in this application to insert the serial number and filing date of this, Filing Date:
This assignment executed on the dates indicated below.	
Ichiro KUMATA	
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of First or sole inventor	
Signature of first or sole inventor	February 1, 2007 Date of this assignment
Signature of first or sole inventor	Date of this assignment

PATENT

REEL: 018983 FRAME: 0826

RECORDED: 02/09/2007